

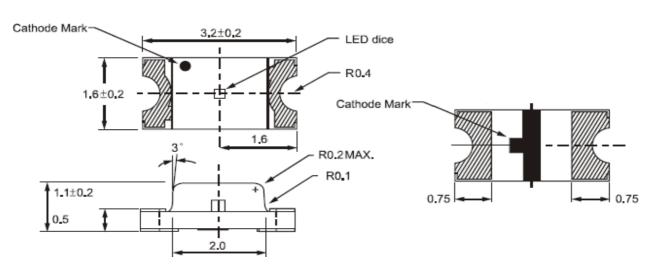


Applications

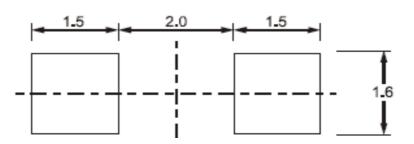
Interior automotive lighting

 Optical indicators
 Communication Products
 Backlighting
 Toys

Technical Drawing



Recommended Soldering Pattern



Notes	All dimensions	s in mm tolerai ss otherwise n	,	SMT Chip LED Yellow Green)		
					Part No.	.: M11	F6005
					Custome	er:	
DRW:	Dong	CHKD	Chang	MATL:	Chui	DATE	05.12.2009
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Absolute Maximum Ratings

Ta=25°C

Item	Symbol	GaP	Unit
Power Dissipation	PD		mW
DC Forward Current	I _F	30	mA
Plused Forward Current	I _{FP} *	100	mA
Reverse Voltage	V _R	5	V
Operating Temperature	T _{OP}	-25 to 80	°C
Storage Temperature	T _{ST}	-30 to 85	°C

* 0.1 msec pulse, 10% duty cycle

Electrcal / Optical Characteristics

I_F=20mA Ta=25°C

Ermitting Color		Yellow Green			
Material	GaP				
Forward Voltage	typ.	2.1	V _F		
Torward Voltage	max.	2.6	V _F		
Wavelength	λD	571	nm		
J	λP	586	nm		
typ.	Δλ		nm		
Color Temperature	min.		K		
	max.		K		
Luminous Intensity *	min.	3.7	mcd		
Lummous intensity	typ.	12	mcd		
Reverse Current	max.		μA		
Viewing Angle	2Θ1/2	120			

* Per NIST standards

SM	T	Chip	LED

Yellow Green

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Directive Characteristics

SMT Chip LED

Yellow Green

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Curvs

SMT Chip LED

Yellow Green

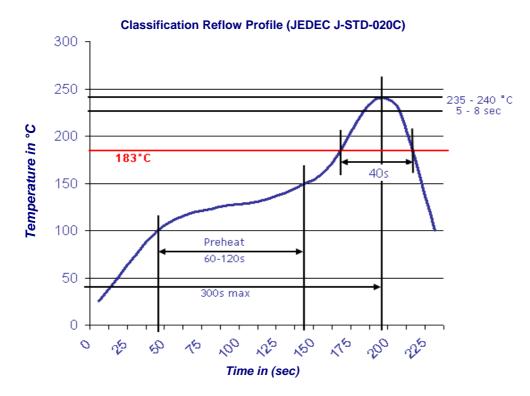
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Solder Condition

Lead Free Solder

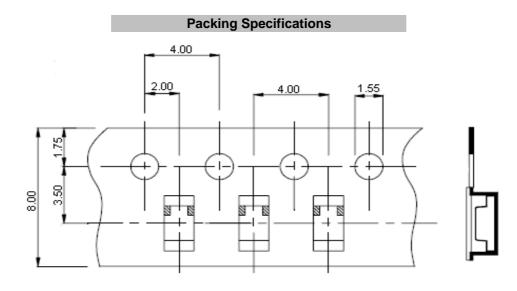


SMT Chip LED Yellow Green

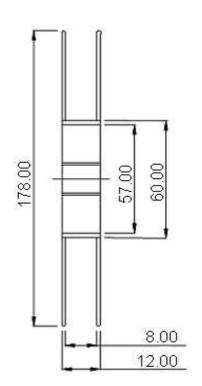
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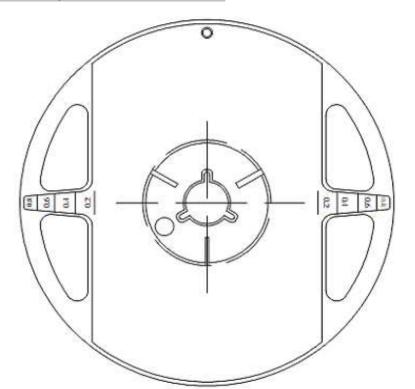






Reel Specifications





					SMT Chip LED Yellow Green Part No.: M11F6005					
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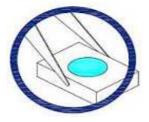




Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although ist characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of th LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools



2. Do not directly touch or handle the silicone lens surfance. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.



						SMT Chip LED Yellow Green)		
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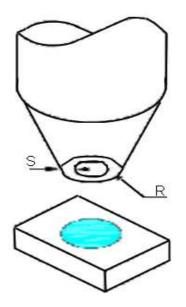
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- 4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



SMT Chip LED

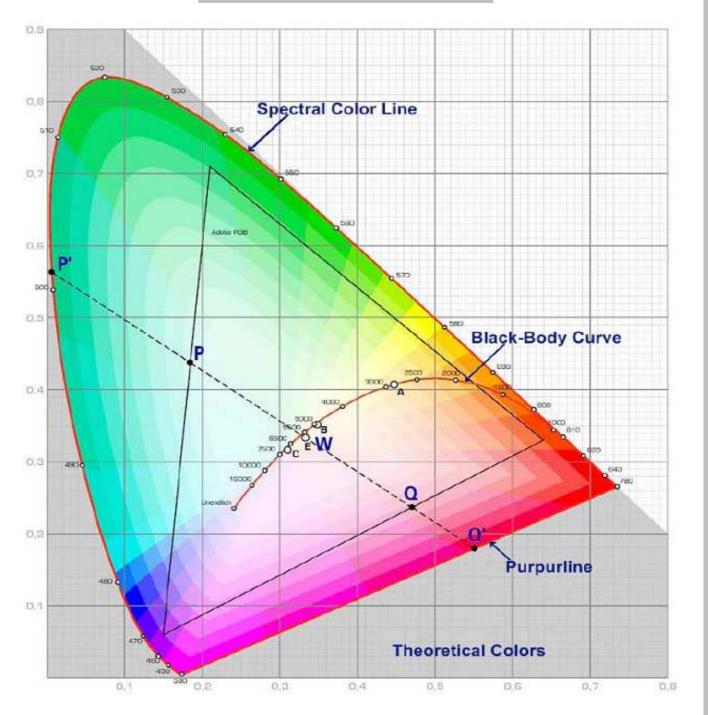
Yellow Green

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Color table curve



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